PTO-1449

U.S. Dept. of Commerce Patent & Trademark Office

List of Documents Cited by Applicant

(Use several sheets if necessary)

Atty. Docket: 97-CC-240 (DIV)

Serial No.: (not yet assigned

Applicant: Pnilippe GAYET et al.

Filing Date: HEREWITH

Group: (not yet assigned)

| | | | U.S. | PATENT DOCUMENTS | | 2/11 | 240 |
|---------------|----------|--------------------|--------------------|---|--------------|---|----------------------------|
| Ex'rs In'l | | Document Number | Date | Name | Class | Syb- Gass/ | Filing Date, applicable |
| C | AA1 | 5,110,712 | May 5, 1992 | Kessler et al. | | | |
| æ | AA2 | 5,244,837 | September 14, 1993 | Dennison . | | | 22 |
| pc | AA3 | 5,451,543 | September 19, 1995 | Woo et al. | | | 632 |
| PC | AA4 | 5,598,027 | January 28, 1997 | Matsuura | | | 0 g |
| x | AA5 | 5,817,574 | October 6, 1998 | Gardner | | | 10 |
| X | AA6 | 5,834,845 | November 1998 | Stolmeijer | | | |
| 2 | AA7 | 5,891,799 | April 1999 | Tsui | | | |
| d l | AA8 | 5,935,868 | August 10, 1999 | Fang et al. | 0 | | |
| | AA9 | 6,020,255 | February 2000 | Tsai et al. | | | |
| Ú | AB1 | 6,048,787 | April 2000 | Lee | | | |
| | | | | | | | |
| | | | FOREIG | ON PATENT DOCUMENTS | | | |
| | | Document Number | Date | Country | Class | Sub- class | Transl'n Yes/No |
| | | | | | + | | |
| | <u> </u> | | | | | | |
| | | | | | | | |
| | | | | | | | |
| | | 0 | THER DOCUMEN | TS (Including Author, Title, Date, Pertinen | Pages, Etc.) | | |
| x | AB2 | - I | | cation number 08241924 dated September | | | |
| | | | | uary 9, 1999 with annex on French Application | | 7. | • |
| P | | | • | | | | |
| | + | | | | | | |
| | | | | · · · · · · · · · · · · · · · · · · · | | | |
| | | | 20.00 | | | - · · · · · · · · · · · · · · · · · · · | |
| • | | | | | | | |
| xamir | nor: | | Data | Considered; | | | |
| AGITHI 157 | HAT | X. CAO | Date | 11/6/02 | | | |

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in

conformance and not considered. Include copy of this form with next communication to applicant.